■Dimensions Unit : mm



■Machine specifications

Model			LC-VALSTER-3015AJ G		
Registered model name			VS3015AJ		
Axis travel method			X-axis and Y-axis: Rack & pinion Z-axis: Ball screw		
Max. processing size X x Y mm			3070 x 1550		
Max. avis travel X x Y x Z mm		mm	3070 x 1550 x 150		
Rapid feed rate	X x Y Axis	m/min	120		
	Z Axis	m/min	80		
Cutting feedrate m/min		m/min	0-120 (maximum commendable speed)		
Pass line mm		mm	940		
Max. material weight kg			920		
Oscillation method			LD-excitation Fiber laser		
Rated laser power W			3000 / 6000 / 10000		
NC model			AMNC-3i Plus		
Partition			Full-partition ceiling open / close integrated telescopic type		
Machine weight (main body only) kg			8600		

■LST specifications

Shuttle table		LST3015G
Maximum material dimensions mm		3070 x 1550
Passing line	mm	940
Maximum work weight	kg	920
Machine weight	kg	3000
Protective device		Area sensor

*Specifications, appearance and equipment are subject to change without notice by reason of improvement.

*The official model names of machines and units described in this catalog are non-hyphenated like LC VALSTER 3015 AJ G.

Use these registered model names when you contact the authorities for applying for installation, exporting, or financing.

The hyphenated spellings like LC-VALSTER-3015AJ G. are used in some portions of this catalog for sake of readability. This also applies to other machines.

*The specifications described in this catalog are for the Overseas market

For Your Safe Use Be sure to read the operator's manual carefully before use.

•Use of this product requires hazard prevention measures to suit your work.

This laser product uses a Class 4 invisible laser for processing and a Class 3R visible laser for positioning.

Class 4 invisible laser: Avoid eye or skin exposure to direct or scattered radiation.
Never look into the radiation nor touch it.
Class 3R visible laser: Avoid direct eye exposure.

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E144-HQ01en Aug. 2022



Processing for thin, medium and thick plates High speed, high production fiber laser machine LC VALSTER 3015 AJ @





Rugged machine body adapted to various situations

Equipped with Beam-shape control technology and processing visualization functions. LC-VALSTER-3015AJ G debut!

LC-VALSTER-3015AJ G enables high speed stable processing of thin to thick materials by utilizing beam-shape control

High quality processing is possible thanks to i-Process Monitoring system.

Additionally various automated systems for detecting processing defects realizing more stable and high quality laser cutting are

Rugged design



High speed, high production fiber laser machine

LC VALSTER 3015 AJ @

Improved machinability

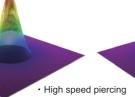
• One Lens operation according to the machine power output





High power oscillator uses longer focus lens for stable thick material processing High speed piercing and high speed processing by beam-shape control

2 Mode converter



· High speed processing of thin materials

processing

2 Adjustment of the joint amount during operation Joint amount can be adjusted during operation.

No need to change the CAM data to adjust the joint amount, this provides continued processing without stopping the machine.



Stable processing and Easy operation



We reviewed various operations that tended to rely on work knowledge and know-how. VALSTER is equipped with various functions that do not interfere with the work flow.

i-Optics Sensor

Diagnoses the condition of the protective glass (LIS*)

Periodically diagnoses the protective Piercing penetration detection and glass to ensure stable cut quality



Latest processing technology (8st)

Medium thick plate incredibly high speed

By using the high power oscillator (6kW&10kW) and the new nozzle in the medium-thick plate, Incredibly high speed processing and operation at low running costs are possible by new processing technology "Clean Fast Cut" and " EZ Fast Cut".

i-Process Monitoring

Monitoring Piercing and cutting condition (LIS*)

processing defects are detected by



Automatic nozzle changer

Automatic nozzle replacement according to material and thickness. Periodic replacement is also possible



Preventing damage due head collision

Protecting the head and stable processing (LIS*)

When a head collision is detected, the Z-axis instantaneously moves upward to prevent damage to the cutting head.



Cooling cut WACS II (Tank:20L)

Stable processing of thick mild

Water mist spray from nozzle to cool the material for stable processing for thick



HP EZ Cut

Reduction of processing cost

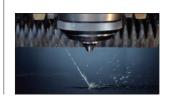
HP EZ Device can produce nitrogen rich gas that can be used as an assist gas. A separate compressor is required. (1300L/1.37MPa)



Oil shot

High quality processing of medium mild steel

Oil spray for protection from adhesion of



*LIS (Laser Integration System) is a generic term for operation support functions, which greatly shortens the setup



Visualization of themachine maintenance and utilization status

- · Condition of the machine
- · Cause of the machine not running
- · Machine operation analysis

Visualization of machine operation, production, and consumption

- · Operating condition of the whole factory
- · Machine operation volume (Production & operation Results)
- · Consumption of materials and energy

Example

Conventional CO₂ lasers (6kW) vs LC-VALSTER-AJ G (6kW)

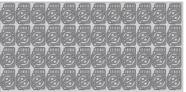


Material : Mild Steel

•Thickness: 2.0mm

•Size: 2438 x 1219mm

Assist gas : Nitrogen

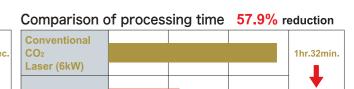


Material : Mild Steel

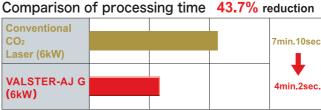
•Thickness : 6.0mm •Size: 2000 x 1000mm

Assist gas : Nitrogen

G00 G00	China		







VALSTER-AJ G (6kW)





